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EFS ID: 64274

Application ID: 10766046



Title of Invention: LEADFRAME TYPE
SEMICONDUCTOR PACKAGE
HAVING REDUCED INDUCTANCE
AND ITS MANUFACTURING
METHOD

First Named Inventor: GI KIM

Domestic/Foreign Application: Domestic Application

Filing Date: 2004-01-28

Effective Receipt Date: 2004-07-09

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Statement

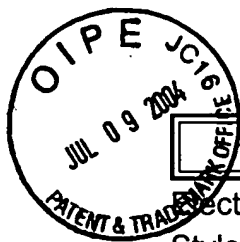
Filing Type:

Confirmation number: 2288

Attorney Docket Number: AMKOR099A


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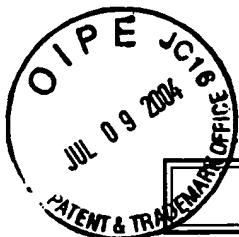
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<p>Application Number: 10/766046 </p> <p>Date: 2004-01-28</p> <p>First Named Applicant: GI JEONG KIM</p> <p>Confirmation Number: 2288</p> <p>Attorney Docket Number: AMKOR099A</p>										
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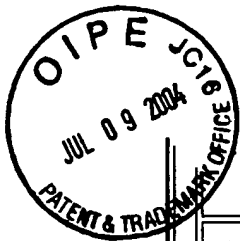


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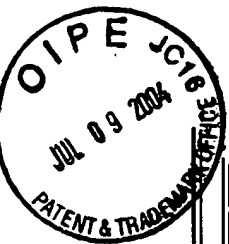
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Note: Applicant is not required to submit a paper copy of cited US Published Applications

init	Cite.No.	Pub. No.	Date	Applicant	Kind	Class	Subclass
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	16	20040065963	2004-04-08	KARNEZOS			

Signature

Examiner Name	Date